

0,635mm Q2™ RIGHTANGLE QMS-RA, SERIES

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS-RA or www.samtec.com?QFS-RA

Insulator Material:

Liquid Crystal Polymer

Terminal & Ground Plane Material: Phosphor Bronze Plating:

Au over 50µ" (1,27µm) Ni (Tin on Ground Plane Tail)

Current Rating: Power Contact: 4.1A @ 80°C Ground Plane: 8.9A @ 80°C Signal Contact: 1.8A @ 80°C Voltage Rating: 300 VAC Operating Temp:

-55°C to +125°C **RoHS Compliant:**

Processing:

Max Processing Temp: 230°C for 60 seconds, or 260°C for 20 seconds 3x Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (026-052) (0,15mm) .006" max (078-104)

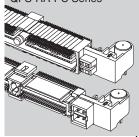
APPLICATION SPECIFIC

- Plastic Guide Post option available.
- -02 lead style for (2,36mm) .093" thick board.

Call Samtec.

ALSO AVAILABLE

Combination Signal/Power See QMS-RA-PC Series or QFS-RA-PC Series

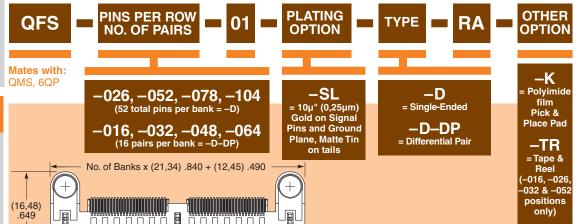


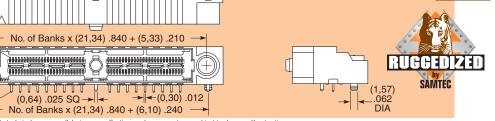
(8, 13)

.320

Note: Some lengths. styles and options are non-standard, non-returnable

PINS PER ROW PLATING **QMS** MG 01 NO. OF PAIRS **OPTION** OPTION **Board** Mates: -D MG **QFS** 026, -052, -078, -104 = Single-Ended = Polyimide (52 total pins per bank = −D) = 10µ" (0,25µm) = Metal film Gold on Signal Pins Guide -D-DP 016, –032, –048, –064 Pick & and Ground Plane, Post Place Pad Matte Tin on tails = Differential Pair (16 pairs per bank = -D-DP)-TR No. of Banks x (21,34) .840 + (12,45) .490 =Tape & Reel (–016, –026, –032 & –052 (11,87)RUGGEDIZED 467 1 positions only) SAMITEC (1,40)055 (5,72)**(0,89)** No. of Banks x (21,34) .840 + (5,33) .210 .035 (8,13) QMS-RA mated to QFS Rated @ -3dB Insertion Loss 8.0 GHz / 16 Gbps (0,30) .012 Single-Ended Signaling (0,64) .025 SQ → Differential Pair Signaling 5.5 GHz / 11.0 Gbps





Due to technical progress, all designs, specifications and components are subject to change without notice.

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(0,64) .025 SQ →

No. of Banks x (21,34) .840 + (6,10) .240